



Product Change Notification



Product Group: Vishay Foil Resistors/ July 7, 2009/ PCN-FD-024-2009, Rev.1

Alternative Bonding Material for VSMP / VSM series

DESCRIPTION OF CHANGE: Vishay Foil Resistors Division qualified an alternative bonding material for small cases of Surface Mount Foil chip resistors without changing the part number.

CLASSIFICATION OF CHANGE: Assembly process/structure.

REASON FOR CHANGE: New generation of material, providing improved adhesion strength.

EXPECTED INFLUENCE ON QUALITY/RELIABILITY/ PERFORMANCE: There will be no effect on the Quality, Reliability, and/or Performance

PRODUCT CATEGORY: Resistors, discrete

PART NUMBERS/SERIES/FAMILIES AFFECTED: VSMP/VSM series (0603, 0805 and 1206)

VISHAY BRAND(s): Vishay Foil Resistors

TIME SCHEDULE:

Start Shipment Date: September 1, 2009

Last Time Buy Date: N/A

Last Time Shipment Date: N/A

SAMPLE AVAILABILITY: Available.

PRODUCT IDENTIFICATION: Green color of top coating.

Qualification Data: Available.

This PCN is considered approved, without further notification, unless we receive specific customer hesitation before: August 1, 2009:

ISSUED BY: Yuval Hernik - Marketing and Sales Director, Foil Resistors

APPROVED BY: Raya Kapelyan - DCCO

APPROVED BY: Yaron Kadim - Vice President Foil Resistors Division

For further information, please contact Foil Division Marketing.

CONTACT INFORMATION:

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